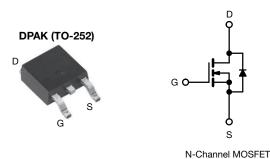
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

E Series Power MOSFET



PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	700		
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.208	
Q _g max. (nC)	29		
Q _{gs} (nC)	8		
Q _{gd} (nC)	7		
Configuration	Single		

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Liahtina
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION		
Package	DPAK (TO-252)	
Lead (Pb)-free and halogen-free	SiHD240N65E-GE3 SiHD240N65ET1-GE3 SiHD240N65ET4-GE3	

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	650	· · · · · · · · · · · · · · · · · · ·	
Gate-source voltage		V_{GS}	± 30	V	
Continuous drain current (T _{.1} = 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	L	16		
Continuous drain current (1 _J = 150 °C)	$T_C = 100 ^{\circ}$ C	I _D	10	Α	
Pulsed drain current ^a		I _{DM}	33		
Linear derating factor			1.2	W/°C	
Single pulse avalanche energy b		E _{AS}	36	mJ	
Maximum power dissipation		P_{D}	147	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope		dv/dt	100	V/ns	
Reverse diode dv/dt c			20	V/11S	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 1.6 A
- c. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	0.6	C/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.65	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
		,	$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zana mata walta sa aluaisa awanant		V _{DS} =	650 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 520 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7 A	-	0.208	0.240	Ω
Forward transconductance a	9 _{fs}	V _{DS}	= 20 V, I _D = 7 A	-	1	-	S
Dynamic		•		•		•	
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	960	-	
Output capacitance	C _{oss}	,	$V_{DS} = 100 \text{ V},$	-	40	-	1
Reverse transfer capacitance	C _{rss}		f = 100 kHz	-	2	-	
Effective output capacitance, energy related ^a	C _{o(er)}	., .,	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		42	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$			273	-	
Total gate charge	Qg			-	19	29	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 7 \text{ A}, V_{DS} = 520 \text{ V}$		8	-	nC
Gate-drain charge	Q _{gd}			-	7	-	
Turn-on delay time	t _{d(on)}			-	16	32	
Rise time	t _r	V _{DD} :	$V_{DD} = 520 \text{ V}, I_D = 7 \text{ A},$		20	40	
Turn-off delay time	t _{d(off)}	V _{GS} =	$=$ 10 V, R _g = 9.1 Ω	-	25	50	ns
Fall time	t _f			-	12	24	
Gate input resistance	R _g	f = 1	f = 1 MHz, Open Drain		0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	16	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	33	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 7 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	-	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 7 \text{A},$		269	538	ns
Reverse recovery charge	Q _{rr}				2.7	5.4	μC
Reverse recovery current	I _{RRM}	di/dt = 100 A/μs, V _R = 25 V		_	17	-	A



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

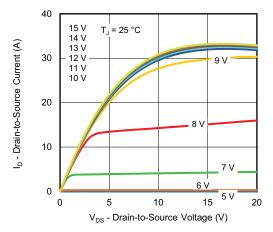


Fig. 1 - Typical Output Characteristics

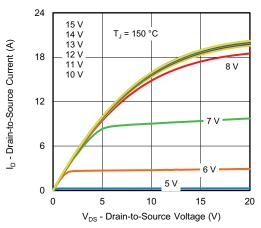


Fig. 2 - Typical Output Characteristics

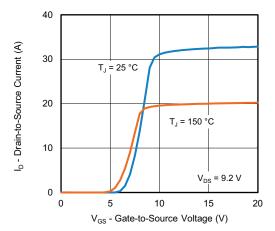


Fig. 3 - Typical Transfer Characteristics

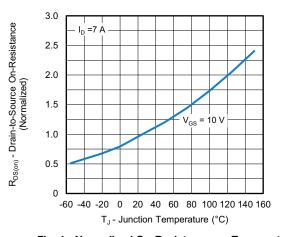


Fig. 4 - Normalized On-Resistance vs. Temperature

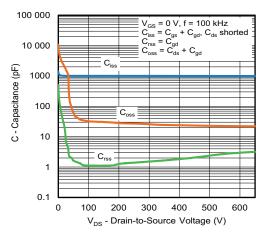


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

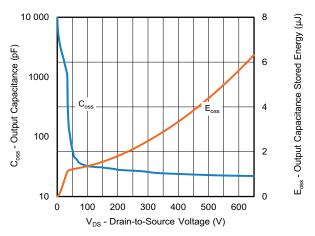


Fig. 6 - Coss and Eoss vs. VDS



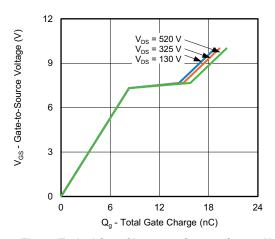


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

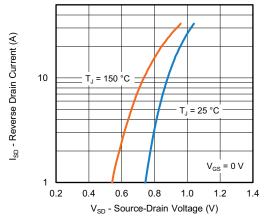


Fig. 8 - Typical Source-Drain Diode Forward Voltage

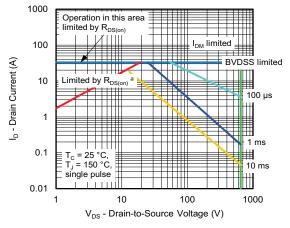


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

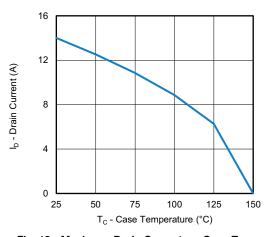


Fig. 10 - Maximum Drain Current vs. Case Temperature

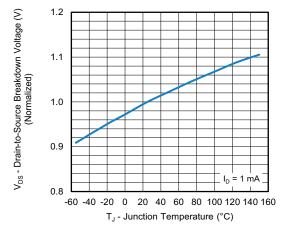


Fig. 11 - Temperature vs. Drain-to-Source Voltage



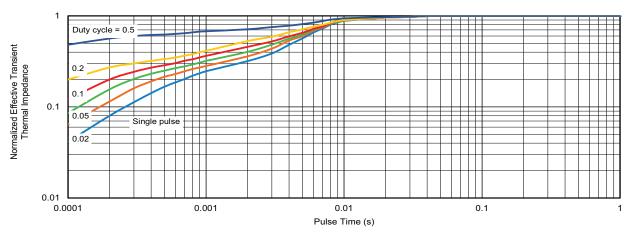


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

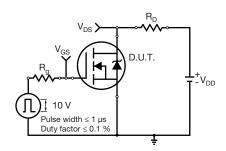


Fig. 13 - Switching Time Test Circuit

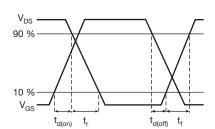


Fig. 14 - Switching Time Waveforms

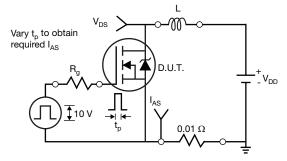


Fig. 15 - Unclamped Inductive Test Circuit

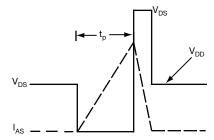


Fig. 16 - Unclamped Inductive Waveforms

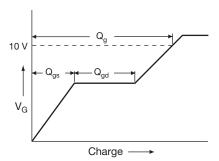


Fig. 17 - Basic Gate Charge Waveform

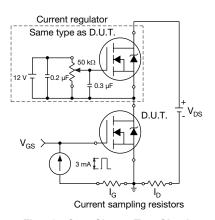
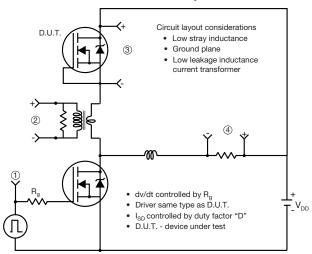


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



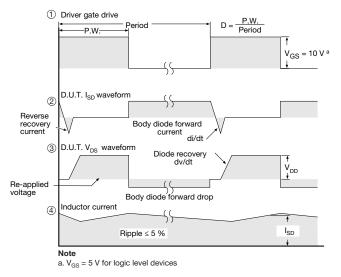


Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92549.



TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	=	
Е	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS	
DIM.	MIN.	MAX.
L	1.50	1.78
L1	2.74	ł ref.
L2	0.51	BSC
L3	0.89	1.27
L4	-	1.02
L5	1.14	1.49
L6	0.65	0.85
θ	0°	10°
θ1	0°	15°
θ2	25°	35°

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022

DWG: 5347



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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